

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hari K. Gutlapalli	12/05/2007
Shirish K. Kothari	12/04/2007
Suhas R. Mehta	12/04/2007
Wai Pak	12/12/2007

RECEIVING PARTY DATA

Name:	Oracle International Corporation
Street Address:	500 Oracle Parkway
Internal Address:	Mail Stop 5OP7
City:	Redwood Shores
State/Country:	CALIFORNIA
Postal Code:	94065

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11875739

CORRESPONDENCE DATA

Fax Number: (512)439-5099

*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*

Phone: 512-439-5090

Email: tstanley@cspatents.com

Correspondent Name: Jonathan N. Geld

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Address Line 2: Building H, Suite 250

Address Line 4: Austin, TEXAS 78758

NAME OF SUBMITTER:

Jonathan N. Geld

Total Attachments: 3

PATENT

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REEL: 020248 FRAME: 0865

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ASSIGNMENT OF APPLICATION FOR PATENT

## WHEREAS:

Union City 94587 Hef 12/05/07  
Hari K. Gutlapalli of Hercules, California 94547  
Shirish K. Kothari of Fremont, California 94555  
Suhaz R. Mehta of San Jose, California 95117-1323  
Wai Pak of Hercules, California 94547

(hereinafter referred to as ASSIGNOR(S)), has made a discovery and/or invention entitled:

METHOD AND APPARATUS FOR EMPLOYING A SEARCHABLE ABSTRACTION  
LAYER OVER ENTERPRISE-WIDE SEARCHABLE OBJECTS

- ☐ for which application for Letters Patent of the United States has been executed on even date herewith,  
☒ for which application for Letters Patent of the United States has been filed on October 19, 2007, under Application No. 11/875,739, and

## WHEREAS:

Oracle International Corporation, a corporation of California, having a business address of 500 Oracle Parkway, Mail Stop 50P7, Redwood Shores, California 94065

and which, together with its successors, assigns, and legal representatives, is hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefor in the United States and in any and all foreign countries.

## NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

Be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sells, assigns and transfers to ASSIGNEE, the full and exclusive right, title and interest to said discovery or invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for said invention by said application or any continuation, continuation-in-part, divisional, reexamination, renewal, substitute, reissue and/or any application claiming priority thereof, including any legal equivalent thereof, in a foreign country for the full term or terms for which the same may be granted.


I, SAID ASSIGNOR(S), hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and any Official of any country or countries foreign to the United States of America whose duty it is to issue Letters Patent on applications as aforesaid, to issue all such Letters Patent for said discovery or invention to the ASSIGNEE, as assignee of the entire right, title and interest in, to and under the same, for the sole use and benefit of the ASSIGNEE in accordance with the terms of this instrument.


I, SAID, ASSIGNOR(S), hereby covenant with ASSIGNEE that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned and that I have full right to convey the entire right, title and interest herein sold, assigned, transferred and set over;

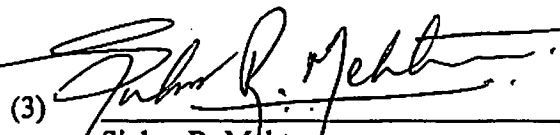
AND I, SAID ASSIGNOR(S) hereby further covenant and agree that the ASSIGNEE may apply for foreign Letters Patent on said discovery or invention and claim the benefits of the International Convention, and that I will, at any time, when called upon to do so by the ASSIGNEE communicate to the ASSIGNEE as the case may be, any facts known to me respecting said discovery or invention, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title to the said discovery or invention, the said applications and the said Letters Patent in the ASSIGNEE and that if reissues or reexaminations of the said Letters Patent or disclaimers relating thereto, or divisionals, continuations, continuation-in-parts of the said applications shall hereafter be desired by the ASSIGNEE, I will, at any time, when called upon to do so by the ASSIGNEE sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers and all divisional, continuation, continuation-in-part, reexamination, and reissue applications so desired, and do all lawful acts requisite for the application for such continuations, continuation-in-parts, divisionals, reexaminations, or reissues and the procuring thereof and for the filing of such disclaimers and such applications, and generally do everything possible to aid the ASSIGNEE to obtain and enforce proper patent protection for said invention or discovery in all countries, all without further compensation but at the expense of the ASSIGNEE.

We further authorize and request the attorneys appointed as representatives in this application to hereafter complete this assignment by inserting above the filing date and application number of this application when known.

Inventor(s): Please Sign and Date Below:

(1)  Date: 12/05/2007  
Hari K. Gutpalli

(2)  Date: 12/04/2007  
Shirish K. Kothari

(3)  Date: 4 Dec 2007  
Suhas R. Mehta  
Suhas  
4 Dec 2007

(4) \_\_\_\_\_ Date: \_\_\_\_\_  
Wai Pak

Attorney Docket No.: QIC0301USPatent

I, SAID, ASSIGNOR(S), hereby covenant with ASSIGNEE that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned and that I have full right to convey the entire right, title and interest herein sold, assigned, transferred and set over;

AND I, SAID ASSIGNOR(S) hereby further covenant and agree that the ASSIGNEE may apply for foreign Letters Patent on said discovery or invention and claim the benefits of the International Convention, and that I will, at any time, when called upon to do so by the ASSIGNEE communicate to the ASSIGNER as the case may be, any facts known to me respecting said discovery or invention, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title to the said discovery or invention, the said applications and the said Letters Patent in the ASSIGNEE and that if reissues or reexaminations of the said Letters Patent or disclaimers relating thereto, or divisionals, continuations, continuation-in-parts of the said applications shall hereafter be desired by the ASSIGNEE, I will, at any time, when called upon to do so by the ASSIGNEE sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers and all divisional, continuation, continuation-in-part, reexamination, and reissue applications so desired, and do all lawful acts requisite for the application for such continuations, continuation-in-parts, divisionals, reexaminations, or reissues and the procuring thereof and for the filing of such disclaimers and such applications, and generally do everything possible to aid the ASSIGNEE to obtain and enforce proper patent protection for said invention or discovery in all countries, all without further compensation but at the expense of the ASSIGNEE.

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**Inventor(s): Please Sign and Date Below:**

(1) \_\_\_\_\_ Date: \_\_\_\_\_  
Ilari K. Gutpalli

(2) \_\_\_\_\_ Date: \_\_\_\_\_  
Shirish K. Kothari

(3) \_\_\_\_\_ Date: \_\_\_\_\_  
Siuhas R. Mehta

(4)  \_\_\_\_\_ Date: 12-12-2007  
Way Pak

Oracle Matter No.  
[OID-2007-189-02]

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